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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

E·XFI

Product Status	Obsolete
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I ² C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	37
Program Memory Size	16KB (5.5K x 24)
Program Memory Type	FLASH
EEPROM Size	512 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5V
Data Converters	A/D 22x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	48-UFQFN Exposed Pad
Supplier Device Package	48-UQFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24fv16km104-e-mv

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4.0 MEMORY ORGANIZATION

As with Harvard architecture devices, the PIC24F microcontrollers feature separate program and data memory space and busing. This architecture also allows the direct access of program memory from the Data Space (DS) during code execution.

4.1 **Program Address Space**

The program address memory space of the PIC24F devices is 4M instructions. The space is addressable by a 24-bit value derived from either the 23-bit Program Counter (PC) during program execution, or from a table operation or Data Space remapping, as described in **Section 4.3 "Interfacing Program and Data Memory Spaces"**.

The user access to the program memory space is restricted to the lower half of the address range (000000h to 7FFFFh). The exception is the use of TBLRD/TBLWT operations, which use TBLPAG<7> to permit access to the Configuration bits and Device ID sections of the configuration memory space.

Memory maps for the PIC24FV16KM204 family of devices are displayed in Figure 4-1.



FIGURE 4-1: PROGRAM SPACE MEMORY MAP FOR PIC24FXXXXX FAMILY DEVICES

4.1.1 PROGRAM MEMORY ORGANIZATION

The program memory space is organized in word-addressable blocks. Although it is treated as 24 bits wide, it is more appropriate to think of each address of the program memory as a lower and upper word, with the upper byte of the upper word being unimplemented. The lower word always has an even address, while the upper word has an odd address (Figure 4-2).

Program memory addresses are always word-aligned on the lower word, and addresses are incremented or decremented by two during code execution. This arrangement also provides compatibility with Data Memory Space Addressing and makes it possible to access data in the program memory space.

4.1.2 HARD MEMORY VECTORS

All PIC24F devices reserve the addresses between 00000h and 000200h for hard-coded program execution vectors. A hardware Reset vector is provided to redirect code execution from the default value of the PC on device Reset to the actual start of code. A GOTO instruction is programmed by the user at 000000h with the actual address for the start of code at 000002h.

PIC24F devices also have two Interrupt Vector Tables, located from 000004h to 0000FFh, and 000104h to 0001FFh. These vector tables allow each of the many device interrupt sources to be handled by separate ISRs. **Section 8.1 "Interrupt Vector Table (IVT)**" discusses the Interrupt Vector Tables in more detail.

4.1.3 DATA EEPROM

In the PIC24FV16KM204 family, the data EEPROM is mapped to the top of the user program memory space, starting at address, 7FFE00, and expanding up to address, 7FFFF.

The data EEPROM is organized as 16-bit-wide memory and 256 words deep. This memory is accessed using Table Read and Write operations similar to the user code memory.

4.1.4 DEVICE CONFIGURATION WORDS

Table 4-1 provides the addresses of the device Configuration Words for the PIC24FV16KM204 family. Their location in the memory map is displayed in Figure 4-1.

Refer to **Section 25.1** "**Configuration Bits**" for more information on device Configuration Words.

TABLE 4-1: DEVICE CONFIGURATION WORDS FOR PIC24FXXXXX FAMILY DEVICES

Configuration Word	Configuration Word Addresses
FBS	F80000
FGS	F80004
FOSCSEL	F80006
FOSC	F80008
FWDT	F8000A
FPOR	F8000C
FICD	F8000E

FIGURE 4-2: PROGRAM MEMORY ORGANIZATION msw most significant word least significant word PC Address (Isw Address) Address 16 8 Λ 23 000000h 000001h 00000000 0000000 000002h 000003h 000004h 00000000 000005h 0000000 000006h 000007h Instruction Width Program Memory Phantom' Byte (read as '0')

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
INTCON1	80h	NSTDIS	—		—	_	—	—	—	—		—	MATHERR	ADDRERR	STKERR	OSCFAIL	—	0000
INTCON2	82h	ALTIVT	DISI	_	_	_	_	_	_	_	_	_	_	_	INT2EP	INT1EP	INT0EP	0000
IFS0	84h	NVMIF	_	AD1IF	U1TXIF	U1RXIF	_	_	CCT2IF	CCT1IF	CCP4IF	CCP3IF	_	T1IF	CCP2IF	CCP1IF	INT0IF	0000
IFS1	86h	U2TXIF	U2RXIF	INT2IF	CCT4IF	CCT3IF	_	_	_	_	CCP5IF	_	INT1IF	CNIF	CMIF	BCL1IF	SSP1IF	0000
IFS2	88h	—	—		_		—	CCT5IF	_	_		—	—	—	_	—	—	0000
IFS3	8Ah	—	RTCIF		—		—	—	—			—	—	—	BCL2IF	SSP2IF	—	0000
IFS4	8Ch	DAC2IF	DAC1IF	CTMUIF	_	_	_	_	HLVDIF		_	_	_	_	U2ERIF	U1ERIF	_	0000
IFS5	8Eh	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	ULPWUIF	0000
IFS6	90h	—	—		—		—	—	—			—	—	—	—	CLC2IF	CLC1IF	0000
IEC0	94h	NVMIE	—	AD1IE	U1TXIE	U1RXIE	—	—	CCT2IE	CCT1IE	CCP4IE	CCP3IE	—	T1IE	CCP2IE	CCP1IE	INT0IE	0000
IEC1	96h	U2TXIE	U2RXIE	INT2IE	CCT4IE	CCT3IE	—	—	—		CCP5IE	—	INT1IE	CNIE	CMIE	BCL1IE	SSP1IE	0000
IEC2	98h	—	—		—		—	CCT5IE	—			—	—	—	—	—	—	0000
IEC3	9Ah	—	RTCIE		—		—	—	—			—	—	—	BCL2IE	SSP2IE	—	0000
IEC4	9Ch	DAC2IE	DAC1IE	CTMUIE	—		—	—	HLVDIE			—	—	—	U2ERIE	U1ERIE	—	0000
IEC5	9Eh	—	—		—		—	—	—			—	—	—	—	—	ULPWUIE	0000
IEC6	A0h	_	_		-		_	_	—			_	—	-	—	CLC2IE	CLC1IE	0000
IPC0	A4h	—	T1IP2	T1IP1	T1IP0	—	CCP2IP2	CCP2IP1	CCP2IP0	_	CCP1IP2	CCP1IP1	CCP1IP0	—	INT0IP2	INT0IP1	INT0IP0	4444
IPC1	A6h	—	CCT1IP2	CCT1IP1	CCT1IP0	—	CCP4IP2	CCP4IP1	CCP4IP0	_	CCP3IP2	CCP3IP1	CCP3IP0	—	—	—	—	4440
IPC2	A8h	—	U1RXIP2	U1RXIP1	U1RXIP0		—	—	—			—	—	—	CCT2IP2	CCT2IP1	CCT2IP0	4004
IPC3	AAh	_	NVMIP2	NVMIP1	NVMIP0		_	_	—		AD1IP2	AD1IP1	AD1IP0	_	U1TXIP2	U1TXIP1	U1TXIP0	4044
IPC4	ACh	—	CNIP2	CNIP1	CNIP0	—	CMIP2	CMIP1	CMIP0	—	BCL1IP2	BCL1IP1	BCL1IP0	—	SSP1IP2	SSP1IP1	SSP1IP0	4444
IPC5	AEh	—	—	—	—	—	CCP5IP2	CCP5IP1	CCP5IP0	—	—	—	—	—	INT1IP2	INT1IP1	INT1IP0	0404
IPC6	B0h	—	CCT3IP2	CCT3IP1	CCT3IP0	—	—	—	—	—	—	—	—	—	—	—	—	4000
IPC7	B2h	—	U2TXIP2	U2TXIP1	U2TXIP0	—	U2RXIP2	U2RXIP1	U2RXIP0	—	INT2IP2	INT2IP1	INT2IP0	—	CCT4IP2	CCT4IP1	CCT4IP0	4444
IPC10	B8h	—	—	—	—	—	—	—	—	—	CCT5IP2	CCT5IP1	CCT5IP0	—	—	—	—	0040
IPC12	BCh	—	—	—	—	—	BCL2IP2	BCL2IP1	BCL2IP0	_	SSP2IP2	SSP2IP1	SSP2IP0	—	—	—	—	0440
IPC15	C2h	—	—		—		RTCIP2	RTCIP1	RTCIP0			—	—	—	—	—	—	0400
IPC16	C4h	—	—		—		U2ERIP2	U2ERIP1	U2ERIP0		U1ERIP2	U1ERIP1	U1ERIP0	—	—	—	—	0440
IPC18	C8h	—	—	—	—	—	—	—	—	—	_	—	—	—	HLVDIP2	HLVDIP1	HLVDIP0	0004
IPC19	CAh	—	DAC2IP2	DAC2IP1	DAC2IP0	—	DAC1IP2	DAC1IP1	DAC1IP0		CTMUIP2	CTMUIP1	CTMUIP0	_		_		4440
IPC20	CCh	_	_	_	—	—	—	—	_	_	_	—	—	_	ULPWUIP2	ULPWUIP1	ULPWUIP0	0004
IPC24	D4h	—	—	_	—	—	—	—	—	—	CLC2IP2	CLC2IP1	CLC2IP0	—	CLC1IP2	CLC1IP1	CLC1IP0	0044
INTTREG	E0h	CPUIRQ	_	VHOLD	—	ILR3	ILR2	ILR1	ILR0		VECNUM6	VECNUM5	VECNUM4	VECNUM3	VECNUM2	VECNUM1	VECNUM0	0000

TABLE 4-5: INTERRUPT CONTROLLER REGISTER MAP

TABLE 4-24: PAD CONFIGURATION REGISTER MAP

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PADCFG1	2FCh	_	_	_		SDO2DIS ⁽¹⁾	SCK2DIS ⁽¹⁾	SDO1DIS	SCK1DIS	_	_	_	_	_	_	_	_	0000

Legend: x = unknown, u = unchanged, — = unimplemented, q = value depends on condition, r = reserved.

Note 1: These bits are not available on the PIC24F(V)08KM101 device, read as '0'.

4.3.2 DATA ACCESS FROM PROGRAM MEMORY AND DATA EEPROM MEMORY USING TABLE INSTRUCTIONS

The TBLRDL and TBLWTL instructions offer a direct method of reading or writing the lower word of any address within the program memory without going through Data Space. It also offers a direct method of reading or writing a word of any address within data EEPROM memory. The TBLRDH and TBLWTH instructions are the only method to read or write the upper 8 bits of a program space word as data.

Note: The TBLRDH and TBLWTH instructions are not used while accessing data EEPROM memory.

The PC is incremented by 2 for each successive 24-bit program word. This allows program memory addresses to directly map to Data Space addresses. Program memory can thus be regarded as two 16-bit, word-wide address spaces, residing side by side, each with the same address range. TBLRDL and TBLWTL access the space which contains the least significant data word, and TBLRDH and TBLWTH access the space which contains the upper data byte.

Two table instructions are provided to move byte or word-sized (16-bit) data to and from program space. Both function as either byte or word operations.

 TBLRDL (Table Read Low): In Word mode, it maps the lower word of the program space location (P<15:0>) to a data address (D<15:0>). In Byte mode, either the upper or lower byte of the lower program word is mapped to the lower byte of a data address. The upper byte is selected when byte select is '1'; the lower byte is selected when it is '0'.

 TBLRDH (Table Read High): In Word mode, it maps the entire upper word of a program address (P<23:16>) to a data address. Note that D<15:8>, the 'phantom' byte, will always be '0'.

In Byte mode, it maps the upper or lower byte of the program word to D<7:0> of the data address, as above. Note that the data will always be '0' when the upper 'phantom' byte is selected (Byte Select = 1).

In a similar fashion, two table instructions, TBLWTH and TBLWTL, are used to write individual bytes or words to a program space address. The details of their operation are explained in **Section 5.0 "Flash Program Memory"**.

For all table operations, the area of program memory space to be accessed is determined by the Table Memory Page Address register (TBLPAG). TBLPAG covers the entire program memory space of the device, including user and configuration spaces. When TBLPAG<7> = 0, the table page is located in the user memory space. When TBLPAG<7> = 1, the page is located in configuration space.

Note: Only Table Read operations will execute in the configuration memory space, and only then, in implemented areas, such as the Device ID. Table Write operations are not allowed.



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REGISTER 8-7: IFS2: INTERRUPT FLAG STATUS REGISTER 2

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0, HS	U-0
_	_	—	—	—	—	CCT5IF	—
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_		_
bit 7							bit 0

Legend:	HS = Hardware Settable bit					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 15-10	Unimplemented: Read as '0'
bit 9	CCT5IF: Capture/Compare 5 Timer Interrupt Flag Status bit
	1 = Interrupt request has occurred
	0 = Interrupt request has not occurred

bit 8-0 Unimplemented: Read as '0'

REGISTER 8-8: IFS3: INTERRUPT FLAG STATUS REGISTER 3

U-0	R/W-0, HS	U-0	U-0	U-0	U-0	U-0	U-0
—	RTCIF	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0, HS	R/W-0, HS	U-0
—	—	—	—	—	BCL2IF	SSP2IF	—
bit 7							bit 0

Legend:	HS = Hardware Settable bit				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15	Unimplemented: Read as '0'
bit 14	RTCIF: Real-Time Clock and Calendar Interrupt Flag Status bit
	1 = Interrupt request has occurred
	0 = Interrupt request has not occurred
bit 13-3	Unimplemented: Read as '0'
bit 2	BCL2IF: MSSP2 I ² C [™] Bus Collision Interrupt Flag Status bit
	1 = Interrupt request has occurred
	0 = Interrupt request has not occurred
bit 1	SSP2IF: MSSP2 SPI/I ² C Event Interrupt Flag Status bit
	1 = Interrupt request has occurred
	0 = Interrupt request has not occurred
bit 0	Unimplemented: Read as '0'

13.4 Input Capture Mode

Input Capture mode is used to capture a timer value from an independent timer base upon an event on an input pin or other internal Trigger source. The input capture features are useful in applications requiring frequency (time period) and pulse measurement. Figure 13-6 depicts a simplified block diagram of Input Capture mode. Input Capture mode uses a dedicated 16/32-bit, synchronous, up counting timer for the capture function. The timer value is written to the FIFO when a capture event occurs. The internal value may be read (with a synchronization delay) using the CCPxTMRH/L register.

To use Input Capture mode, the CCSEL bit (CCPxCON1L<4>) must be set. The T32 and the MOD<3:0> bits are used to select the proper Capture mode, as shown in Table 13-4.

MOD<3:0> (CCPxCON1L<3:0>)	T32 (CCPxCON1L<5>)	Operating Mode
0000	0	Edge Detect (16-bit capture)
0000	1	Edge Detect (32-bit capture)
0001	0	Every Rising (16-bit capture)
0001	1	Every Rising (32-bit capture)
0010	0	Every Falling (16-bit capture)
0010	1	Every Falling (32-bit capture)
0011	0	Every Rise/Fall (16-bit capture)
0011	1	Every Rise/Fall (32-bit capture)
0100	0	Every 4th Rising (16-bit capture)
0100	1	Every 4th Rising (32-bit capture)
0101	0	Every 16th Rising (16-bit capture)
0101	1	Every 16th Rising (32-bit capture)

TABLE 13-4: INPUT CAPTURE MODES





16.2 RTCC Module Registers

The RTCC module registers are organized into three categories:

- RTCC Control Registers
- RTCC Value Registers
- · Alarm Value Registers

16.2.1 REGISTER MAPPING

To limit the register interface, the RTCC Timer and Alarm Time registers are accessed through corresponding register pointers. The RTCC Value register window (RTCVALH and RTCVALL) uses the RTCPTRx bits (RCFGCAL<9:8>) to select the desired Timer register pair (see Table 16-1).

By writing the RTCVALH byte, the RTCC Pointer value, the RTCPTR<1:0> bits decrement by one until they reach '00'. Once they reach '00', the MINUTES and SECONDS value will be accessible through RTCVALH and RTCVALL until the pointer value is manually changed.

TABLE 16-1: RTCVAL REGISTER MAPPING

	RTCC Value Register Window				
RIGFIRE1.02	RTCVAL<15:8>	RTCVAL<7:0>			
00	MINUTES	SECONDS			
01	WEEKDAY	HOURS			
10	MONTH	DAY			
11	_	YEAR			

The Alarm Value register window (ALRMVALH and ALRMVALL) uses the ALRMPTRx bits (ALCFGRPT<9:8>) to select the desired Alarm register pair (see Table 16-2).

By writing the ALRMVALH byte, the ALRMPTR<1:0> bits (Alarm Pointer value) decrement by one until they reach '00'. Once they reach '00', the ALRMMIN and ALRMSEC value will be accessible through ALRMVALH and ALRMVALL, until the pointer value is manually changed.

TABLE 16-2: ALRMVAL REGISTER MAPPING

ALRMPTR	Alarm Value Register Window			
<1:0>	ALRMVALH<15:8>	ALRMVALL<7:0>		
00	ALRMMIN	ALRMSEC		
01	ALRMWD	ALRMHR		
10	ALRMMNTH	ALRMDAY		
11	PWCSTAB	PWCSAMP		

Considering that the 16-bit core does not distinguish between 8-bit and 16-bit read operations, the user must be aware that when reading either the ALRMVALH or ALRMVALL bytes, the ALRMPTR<1:0> value will be decremented. The same applies to the RTCVALH or RTCVALL bytes with the RTCPTR<1:0> being decremented.

Note: This only applies to read operations and not write operations.

16.2.2 WRITE LOCK

In order to perform a write to any of the RTCC Timer registers, the RTCWREN bit (RCFGCAL<13>) must be set (see Example 16-1 and Example 16-2).

Note:	To avoid accidental writes to the timer, it is recommended that the RTCWREN bit (RCFGCAL<13>) is kept clear at any other time. For the RTCWREN bit to be set, there is only one instruction cycle time window allowed between the 55h/AA
	sequence and the setting of RTCWREN.
	Therefore, it is recommended that code
	follow the procedure in Example 16-2.

16.2.3 SELECTING RTCC CLOCK SOURCE

There are four reference source clock options that can be selected for the RTCC using the RTCCLK<1:0> bits (RTCPWC<11:10>): 00 = Secondary Oscillator, 01 = LPRC, 10 = 50 Hz External Clock and 11 = 60 Hz External Clock.

EXAMPLE 16-1:	SETTING THE RTCWREN BIT	IN ASSEMBLY

push	w7	; Store W7 and W8 values on the stack.
push	w8	
disi	#5	; Disable interrupts until sequence is complete.
mov	#0x55, w7	; Write 0x55 unlock value to NVMKEY.
mov	w7, NVMKEY	
mov	#0xAA, w8	; Write OxAA unlock value to NVMKEY.
mov	w8, NVMKEY	
bset	RCFGCAL, #13	; Set the RTCWREN bit.
pop	w8	; Restore the original W register values from the stack.
pop	w7	

EXAMPLE 16-2: SETTING THE RTCWREN BIT IN 'C'

//This builtin function executes implements the unlock sequence and sets
//the RTCWREN bit.
__builtin_write_RTCWEN();

U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
_	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 15							bit 8
U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 7					•		bit 0
Legend:							
R = Readabl	le bit	W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unknown	
bit 15	Unimplement	ed: Read as '0	,				
bit 14-12	MINTEN<2:0	Binary Code	d Decimal Valu	ue of Minute's T	ens Digit bits		
	Contains a va	lue from 0 to 5					
bit 11-8	MINONE<3:0	>: Binary Code	ed Decimal Val	ue of Minute's (Ones Digit bits		
	Contains a va	lue from 0 to 9					
bit 7	bit 7 Unimplemented: Read as '0'						
bit 6-4	6-4 SECTEN<2:0>: Binary Coded Decimal Value of Second's Tens Digit bits						
	Contains a va	lue from 0 to 5					
bit 3-0	SECONE<3:0	>: Binary Code	ed Decimal Val	lue of Second's	Ones Digit bits	6	
	Contains a va	lue from 0 to 9					

REGISTER 16-10: ALMINSEC: ALARM MINUTES AND SECONDS VALUE REGISTER

NOTES:

To perform an A/D conversion:

- 1. Configure the A/D module:
 - a) Configure the port pins as analog inputs and/or select band gap reference inputs (ANSx registers).
 - b) Select the voltage reference source to match the expected range on the analog inputs (AD1CON2<15:13>).
 - c) Select the analog conversion clock to match the desired data rate with the processor clock (AD1CON3<7:0>).
 - d) Select the appropriate sample/conversion sequence (AD1CON1<7:4> and AD1CON3<12:8>).
 - e) Configure the MODE12 bit to select A/D resolution (AD1CON1<10>).
 - f) Select how conversion results are presented in the buffer (AD1CON1<9:8>).
 - g) Select the interrupt rate (AD1CON2<6:2>).
 - h) Turn on the A/D module (AD1CON1<15>).
- 2. Configure the A/D interrupt (if required):
 - a) Clear the AD1IF bit.
 - b) Select the A/D interrupt priority.

To perform an A/D sample and conversion using Threshold Detect scanning:

- 1. Configure the A/D module:
 - a) Configure the port pins as analog inputs (ANSx registers).
 - b) Select the voltage reference source to match the expected range on the analog inputs (AD1CON2<15:13>).
 - c) Select the analog conversion clock to match the desired data rate with the processor clock (AD1CON3<7:0>).
 - d) Select the appropriate sample/conversion sequence (AD1CON1<7:4> and AD1CON3<12:8>).
 - e) Configure the MODE12 bit to select A/D resolution (AD1CON1<10>).
 - f) Select how the conversion results are presented in the buffer (AD1CON1<9:8>).
 - g) Select the interrupt rate (AD1CON2<6:2>).

- 2. Configure the threshold compare channels:
 - a) Enable auto-scan; set the ASEN bit (AD1CON5<15>).
 - b) Select the Compare mode, "Greater Than, Less Than or Windowed"; set the CMx bits (AD1CON5<1:0>).
 - c) Select the threshold compare channels to be scanned (AD1CSSH, AD1CSSL).
 - d) If the CTMU is required as a current source for a threshold compare channel, enable the corresponding CTMU channel (AD1CTMENH, AD1CTMENL).
 - e) Write the threshold values into the corresponding ADC1BUFx registers.
 - f) Turn on the A/D module (AD1CON1<15>).
- Note: If performing an A/D sample and conversion, using Threshold Detect in Sleep Mode, the RC A/D clock source must be selected before entering into Sleep mode.
- 3. Configure the A/D interrupt (OPTIONAL):
 - a) Clear the AD1IF bit.
 - b) Select the A/D interrupt priority.

R/W-0	R/W-0	R/W-0	R/W-0	r-0	U-0	R/W-0	R/W-0
ASEN ⁽¹⁾	LPEN	CTMREQ	BGREQ	r	—	ASINT1	ASINT0
bit 15							bit 8
r							
U-0	U-0	<u>U-0</u>	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	_		—	WM1	WM0	CM1	CM0
bit 7							bit 0
Legend		r - Reserved k	nit				
R = Read	ahle hit	W = Writable k	h	II = I Inimplem	ented hit read	as 'O'	
-n = Value	at POR	'1' = Rit is set		$0^{\circ} = \text{Bit is clear}$	ured	x = Bit is unkn	iown
II = Value					lica		own
bit 15	ASEN: A/D A	uto-Scan Enable	e bit ⁽¹⁾				
	1 = Auto-sca	n is enabled					
	0 = Auto-sca	n is disabled					
bit 14	LPEN: A/D Lo	w-Power Enabl	e bit				
	1 = Returns t	o Low-Power m	ode after scan				
hit 13	CTMREQ: CT	MII Request bi					
bit 10	1 = CTMU is	enabled when t	he A/D is enab	led and active			
	0 = CTMU is	not enabled by	the A/D				
bit 12	BGREQ: Ban	d Gap Request	bit				
	1 = Band gap	is enabled whe	en the A/D is e	nabled and activ	/e		
1.11.4.4	0 = Band gap	is not enabled	by the A/D				
DIT 11	Reserved: Ma	aintain as '0'					
		Ied: Read as '0'	a a h a l d D a t a at)		b:to		
DII 9-8		Auto-Scan (Thr	esnoid Detect) Id Dotoct soci		Dits	id compare has	occurred
	10 = Interrupt	after a valid co	mpare has occ	urred	ieleu aliu a vai	iu compare nas	occurred
	01 = Interrupt	after a Thresho	Id Detect sequ	ience has comp	leted		
	00 = No interi	upt					
bit 7-4	Unimplement	ted: Read as '0'					
bit 3-2	WM<1:0>: A/	D Write Mode bi	ts				
	11 = Reserve 10 = Auto-cor	a moare only (cor	version result	s are not save	hut interrunt	s are generated	d when a valid
	match, a	is defined by the	CMx and AS	NTx bits, occurs	5)	e ale generate.	
	01 = Convert	and save (conve	ersion results a	are saved to loca	ations as deterr	nined by the reo	gister bits when
	a match = 1 eqacy (, as defined by t	ne Civix bits, o ersion data is s	ccurs) aved to a locati	on determined	by the buffer re	aister bits)
bit 1-0	CM<1:0>: A/[Compare Mod	e bits				9.0101 0.10)
	11 = Outside	Window mode (v	alid match occ	curs if the conve	rsion result is ou	utside of the win	dow defined by
	the corre	sponding buffer	pair)				
	10 = Inside W	/Indow mode (va Inding buffer pair	alid match occl	irs if the convers	sion result is ins	side the window	defined by the
01 = Greater Than mode (valid match occurs if the result is greater than the value in the corresponding						sponding buffer	
	register)			-			
	00 = Less That	an mode (valid ma	atch occurs if th	e result is less th	an the value in th	ne correspondin	g butter register)
Note 1:	When using au	to-scan with Th	reshold Detect	(ASEN = 1), do	not configure	the sample cloc	k source to
	Auto-Convert n the sample clo	node (SSRC<3: ck source (SSR	0> = 7). Any ot C<3:0> = 7), m	her available SS nake sure ASEN	SRC selection is I is cleared.	s valid. To use a	uto-convert as

REGISTER 19-4: AD1CON5: A/D CONTROL REGISTER 5

19.3 Transfer Function

The transfer functions of the A/D Converter in 12-bit resolution are shown in Figure 19-3. The difference of the input voltages (VINH – VINL) is compared to the reference ((VR+) – (VR-)).

- The first code transition occurs when the input voltage is ((VR+) (VR-))/4096 or 1.0 LSb.
- The '0000 0000 0001' code is centered at VR- + (1.5 * ((VR+) (VR-))/4096).

- The '0010 0000 0000' code is centered at VREFL + (2048.5 * ((VR+) – (VR-))/4096).
- An input voltage less than VR- + (((VR-) – (VR-))/4096) converts as '0000 0000 0000'.
- An input voltage greater than (VR-) + (4095 ((VR+) – (VR-))/4096) converts as '1111 1111 1111'.



FIGURE 19-3: 12-BIT A/D TRANSFER FUNCTION

REGISTER 25-4: FOSC: OSCILLATOR CONFIGURATION REGISTER

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
FCKSM1	FCKSM0	SOSCSEL	POSCFREQ1	POSCFREQ0	OSCIOFNC	POSCMD1	POSCMD0
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6	FCKSM<1:0>: Clock Switching and Fail-Safe Clock Monitor Selection Configuration bits 1x = Clock switching is disabled, Fail-Safe Clock Monitor is disabled 01 = Clock switching is enabled, Fail-Safe Clock Monitor is disabled 00 = Clock switching is enabled, Fail-Safe Clock Monitor is enabled
bit 5	SOSCSEL: Secondary Oscillator Power Selection Configuration bit 1 = Secondary Oscillator is configured for high-power operation 0 = Secondary Oscillator is configured for low-power operation
bit 4-3	POSCFREQ<1:0>: Primary Oscillator Frequency Range Configuration bits 11 = Primary Oscillator/External Clock input frequency is greater than 8 MHz 10 = Primary Oscillator/External Clock input frequency is between 100 kHz and 8 MHz 01 = Primary Oscillator/External Clock input frequency is less than 100 kHz 00 = Reserved; do not use
bit 2	 OSCIOFNC: CLKO Enable Configuration bit 1 = CLKO output signal is active on the OSCO pin; Primary Oscillator must be disabled or configured for the External Clock (EC) mode for the CLKO to be active (POSCMD<1:0> = 11 or 00) 0 = CLKO output is disabled
bit 1-0	POSCMD<1:0>: Primary Oscillator Configuration bits 11 = Primary Oscillator mode is disabled 10 = HS Oscillator mode is selected 01 = XT Oscillator mode is selected

00 = External Clock mode is selected



FIGURE 27-13: EXAMPLE SPI SLAVE MODE TIMING (CKE = 0)

Param No.	Symbol	Characteristic	Characteristic		Max	Units	Conditions
70	TssL2scH, TssL2scL	$\overline{\text{SSx}} \downarrow$ to SCKx \downarrow or SCKx \uparrow Input	$\overline{4} \downarrow$ to SCKx \downarrow or SCKx \uparrow Input			ns	
70A	TssL2WB	SSx to Write to SSPxBUF		3 TCY	_	ns	
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30		ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73	TDIV2scH, TDIV2scL	Setup Time of SDIx Data Input to SCKx	20	_	ns		
73A	Тв2в	Last Clock Edge of Byte 1 to the First Clo	ck Edge of Byte 2	1.5 Tcy + 40	_	ns	(Note 2)
74	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx	40		ns		
75	TDOR	SDOx Data Output Rise Time		—	25	ns	
76	TDOF	SDOx Data Output Fall Time		—	25	ns	
77	TssH2doZ	SSx ↑ to SDOx Output High-Impedance	10	50	ns		
80	TscH2doV, TscL2doV	SDOx Data Output Valid After SCKx Edge		—	50	ns	
83	TscH2ssH, TscL2ssH	SSx ↑ After SCKx Edge		1.5 TCY + 40	—	ns	
	FSCK	SCKx Frequency		_	10	MHz	

TABLE 27-31: EXAMPLE SPI MODE REQUIREMENTS (SLAVE MODE TIMING, CKE = 0)

Note 1: Requires the use of Parameter 73A.

2: Only if Parameters 71A and 72A are used.



TABLE 27-36: I²C[™] BUS DATA REQUIREMENTS (MASTER MODE)

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
100	Thigh	Clock High Time	100 kHz mode	2(Tosc)(BRG + 1)	—		
			400 kHz mode	2(Tosc)(BRG + 1)	—		
101	TLOW	Clock Low Time	100 kHz mode	2(Tosc)(BRG + 1)	_	—	
			400 kHz mode	2(Tosc)(BRG + 1)	_		
102	TR	SDAx and SCLx	100 kHz mode	—	1000	ns	CB is specified to be from
		Rise Time	400 kHz mode	20 + 0.1 Св	300	ns	10 to 400 pF
103	TF	SDAx and SCLx	100 kHz mode	—	300	ns	CB is specified to be from
		Fall Time	400 kHz mode	20 + 0.1 Св	300	ns	10 to 400 pF
90	TSU:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	—	—	Only relevant for Repeated
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_		Start condition
91	THD:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	—	After this period, the first
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	—		clock pulse is generated
106	THD:DAT	Data Input	100 kHz mode	0	—	ns	
		Hold Time	400 kHz mode	0	0.9	μS	
107	TSU:DAT	Data Input	100 kHz mode	250	_	ns	(Note 1)
		Setup Time	400 kHz mode	100	_	ns	
92	Tsu:sto	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_		
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	—		
109	ΤΑΑ	Output Valid	100 kHz mode	—	3500	ns	
		from Clock	400 kHz mode	—	1000	ns	
110	TBUF	Bus Free Time	100 kHz mode	4.7	—	μS	Time the bus must be free
			400 kHz mode	1.3	_	μS	before a new transmission can start
D102	Св	Bus Capacitive L	oading	_	400	pF	

Note 1: A Fast mode I²C bus device can be used in a Standard mode I²C bus system, but Parameter 107 ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLx signal. If such a device does stretch the LOW period of the SCLx signal, it must output the next data bit to the SDAx line, Parameter 102 + Parameter 107 = 1000 + 250 = 1250 ns (for 100 kHz mode), before the SCLx line is released.

AC CHARACTERISTICS			$\label{eq:standard Operating Conditions: 1.8V to 3.6V (PIC24F16KM204) \\ 2.0V to 5.5V (PIC24FV16KM204) \\ -40^{\circ}C \leq TA \leq +85^{\circ}C \text{ for Industrial} \\ -40^{\circ}C \leq TA \leq +125^{\circ}C \text{ for Extended} \\ \end{array}$				
Param No.	Sym	Characteristic	Min.	Тур	Max.	Units	Comments
		Resolution	8	—	_	bits	
		DACREF<1:0> Input Voltage Range	AVss + 1.8	—	AVDD	V	
		Differential Linearity Error (DNL)	—	—	±0.5	LSb	
		Integral Linearity Error (INL)	—	—	±1.5	LSb	
		Offset Error	—	—	±0.5	LSb	
		Gain Error	—	—	±3.0	LSb	
		Monotonicity	—	—	—	—	(Note 1)
		Output Voltage Range	AVss + 50	AVss + 5 to AVpp – 5	AVDD - 50	mV	0.5V input overdrive, no output loading
		Slew Rate	—	5	_	V/µs	
		Settling Time	—	10	—	μs	

TABLE 27-39: 8-BIT DIGITAL-TO-ANALOG CONVERTER SPECIFICATIONS

Note 1: DAC output voltage never decreases with an increase in the data code.

28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS			
Dimension Limits		MIN	NOM	MAX
Contact Pitch E		0.65 BSC		
Optional Center Pad Width	W2			4.25
Optional Center Pad Length	T2			4.25
Contact Pad Spacing	C1		5.70	
Contact Pad Spacing	C2		5.70	
Contact Pad Width (X28)	X1			0.37
Contact Pad Length (X28)	Y1			1.00
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

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